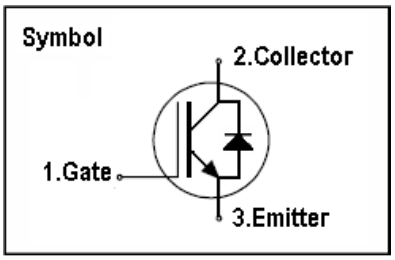
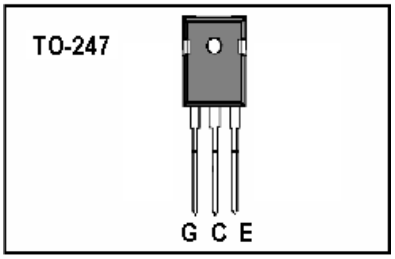
IGBT

Features





- 600V,50A
- $V_{CE(sat)(typ.)}$=2.0V@V_{GE}=15V,I_C=50A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

General Description

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as SMPS, general inverter and other switching applications.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	600	V
V_{GES}	Gate-Emitter Voltage	± 30	V
I_C	Continuous Collector Current (T_C=25℃)	90	A
	Continuous Collector Current (T_C=100℃)	50	A
I_{CM}	Pulsed Collector Current (Note 1)	150	A
I_F	Diode Continuous Forward Current (T_C=100℃)	50	A
I_{FM}	Diode Maximum Forward Current (Note 1)	150	A
t_{sc}	Short Circuit Withstand Time	10	us
P_D	Maximum Power Dissipation (T_C=25℃)	250	W
	Maximum Power Dissipation (T_C=100℃)	100	W
T_J	Operating Junction Temperature Range	-55 to +150	℃
T_{STG}	Storage Temperature Range	-55 to +150	℃

Thermal Characteristics

Symbol	Parameter	Max.	Units
$R_{th\,j\text{-}c}$	Thermal Resistance, Junction to case for IGBT	0.5	K/W
$R_{th\,j\text{-}c}$	Thermal Resistance, Junction to case for Diode	0.8	K/W
$R_{th\,j\text{-}a}$	Thermal Resistance, Junction to Ambient	40	K/ W

Electrical Characteristics (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{CES}	Collector-Emitter Breakdown Voltage	V_{GE}= 0V, I_C= 250uA	600	-	-	V
I_{CES}	Collector-Emitter Leakage Current	V_{CE}= 600V, V_{GE}= 0V	-	-	100	uA
I_{GES}	Gate Leakage Current, Forward	V_{GE}=30V, V_{CE}= 0V	-	-	100	nA
	Gate Leakage Current, Reverse	V_{GE}= -30V, V_{CE}= 0V	-	-	100	nA
$V_{GE(th)}$	Gate Threshold Voltage	V_{GE}= V_{CE}, I_C= 250uA	4.5	-	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	V_{GE}=15V, I_C= 40A	-	2.0	2.5	V
Qg	Total Gate Charge	V_{CC}=400V V_{GE}=15V I_C=50A	-	110		nC
Qge	Gate-Emitter Charge		-	35		nC
Qgc	Gate-Collector Charge		-	44		nC
$t_{d(on)}$	Turn-on Delay Time	V_{CC}=400V V_{GE}=15V I_C=40A R_G=28Ω Inductive Load T_C=25℃	-	35	-	ns
t_r	Turn-on Rise Time		-	38	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	275	-	ns
t_f	Turn-off Fall Time		-	53	-	ns
Eon	Turn-on Switching Loss		-	1.35	-	mJ
Eoff	Turn-off Switching Loss		-	1.5	-	mJ
Ets	Total Switching Loss		-	2.85	-	mJ
Cies	Input Capacitance	V_{CE}=25V V_{GE}=0V f = 1MHz	-	3050	-	pF
Coes	Output Capacitance		-	260	-	pF
Cres	Reverse Transfer Capacitance		-	115	-	pF

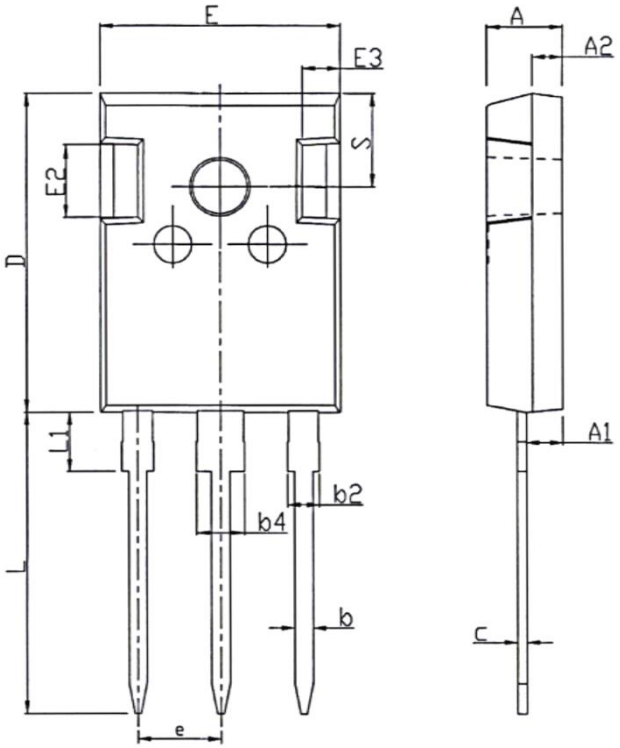
Electrical Characteristics of Diode (T_C=25℃ unless otherwise noted)

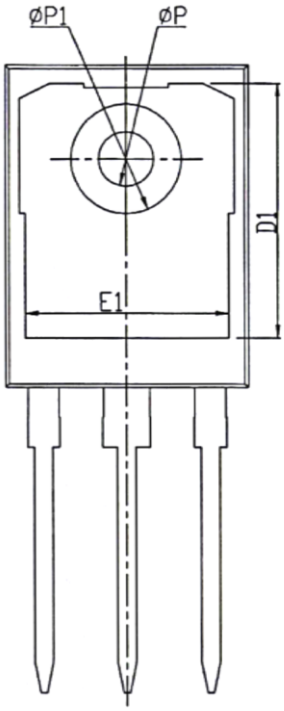
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	I_F= 50A	-	1.5	2.0	V
t_{rr}	Diode Reverse Recovery Time	V_{CE} = 400V I_F= 50A dIF/dt = 200A/us	-	90		ns
I_{rr}	Diode peak Reverse Recovery Current		-	35		A
Q_{rr}	Diode Reverse Recovery Charge		-	1.96		uC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

封装外型





SYMBOL	MM		
	MIN	NOM	MAX
A	4.8	5	5.2
A1	2.21	2.41	2.61
A2	1.85	2	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.7	21	21.3
D1	16.25	16.55	16.85
E	15.5	15.8	16.1
E1	13	13.3	13.6
E2	1.8	5	5.2
E3	2.3	2.5	2.7
e	5.44 BSC		
L	19.62	19.92	20.22
L1	-	-	4.3
ΦP	3.4	3.6	3.8
ΦP1	-	-	7.3
S	6.15 BSC		

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